



Letter No: 2205 /DPMU/BDH/2018

Date: 04 / 10 /2018

## Quotation Call Notice IEC Material

Sealed quotations are invited from the Agencies / Individuals for supply of different printing IEC/BCC works material under NHM, Boudh. The tender papers along with terms & conditions will be available at district portal '[www.boudh.nic.in](http://www.boudh.nic.in)'. The sealed Tender envelope containing separate two bids technical & financial bid in separate cover superscribing tender for supply of different printing IEC/BCC works material should reach to the "CDM&PHO Boudh, Pin- 762014 on or before 25.10.2018 at 05 PM along with all the relevant documents through Speed Post/Regd. Post/ courier only. The tender will be opened on 26.10.2018.....at 11 AM.. in the office chamber of the undersigned. The undersigned reserves the right to reject any or all the tender without any reason thereof.

Sd/-

CDM&PHO-cum-District Mission Director, Boudh

TENDERS ARE INVITED FROM ELIGIBLE BIDDERS AS PER THE ELIGIBILITY CRITERIA FOR SUPPLY OF IEC WORKS MATERIAL UNDER NHM BOUDH.

1	Period of Availability of Tender Document	From <b>05-10-2018 to 25-10-2018</b> (Downloadable from website: <a href="http://www.boudh.nic.in">www.boudh.nic.in</a> ) In case of any bid amendment and clarification, responsibility lies with the bidders to collect the same from the above mentioned website before last date of submission of tender document and the tender inviting authority shall have no responsibility for any delay / omission on part of the bidder.
2	Last date & time for submission of Tender	<b>Date: 25-10-2018, Time: 05 PM</b>  <b>Address of Submission of Bid:</b> OFFICE OF THE CHIEF DISTRICT MEDICAL OFFICER -BOUDH DISTRICT HEADQUARTER HOSPITAL, BOUDH DIST- BOUDH PIN- 762014 (Through Speed post / Registered post / Courier )
3	Date, time and place of opening of Tender	a) <b>Technical Bid (Cover A) opening 26-10-2018 at 11.00 AM at the address mentioned above.</b> b) <b>Financial Bid (Cover B):</b> <i>The date of opening of financial bid will be intimated to the firms found successful in the technical bid evaluation.</i> <i>( Venue is mentioned at the address mentioned above)</i> <i>(Bidders / authorized representative may remain present at the time of opening of bid)</i>



